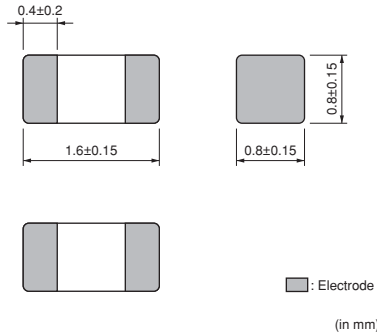


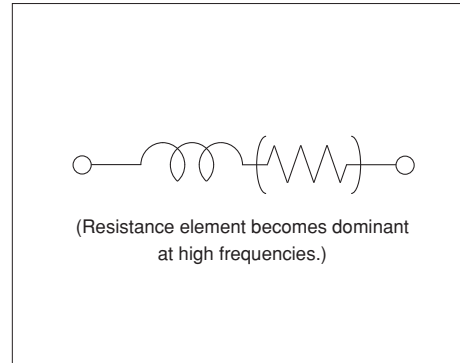
EMIFIL® (Inductor type) Chip Ferrite Bead

BLM18P Series (0603 Size)

■ Dimensions



■ Equivalent Circuit



■ Packaging

Code	Packaging	Minimum Quantity
D	180mm Paper Tape	4000
J	330mm Paper Tape	10000
B	Bulk(Bag)	1000

■ Rated Value (□: packaging code)

Part Number	Impedance (at 100MHz/20°C)	Impedance (at 1GHz/20°C)	Rated Current	DC Resistance	Operating Temperature Range
BLM18PG300SN1□	30ohm (Typ.)	-	1000mA	0.05ohm max.	-55 to +125°C
BLM18PG330SN1□	33ohm ±25%	-	3000mA	0.025ohm max.	-55 to +125°C
BLM18PG600SN1□	60ohm (Typ.)	-	500mA	0.10ohm max.	-55 to +125°C
BLM18PG121SN1□	120ohm ±25%	-	2000mA	0.05ohm max.	-55 to +125°C
BLM18PG181SN1□	180ohm ±25%	-	1500mA	0.09ohm max.	-55 to +125°C
BLM18PG221SN1□	220ohm ±25%	-	1400mA	0.10ohm max.	-55 to +125°C
BLM18PG331SN1□	330ohm ±25%	-	1200mA	0.15ohm max.	-55 to +125°C
BLM18PG471SN1□	470ohm ±25%	-	1000mA	0.20ohm max.	-55 to +125°C

Number of Circuits: 1

Continued on the following page.

● This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

⚠ Note:

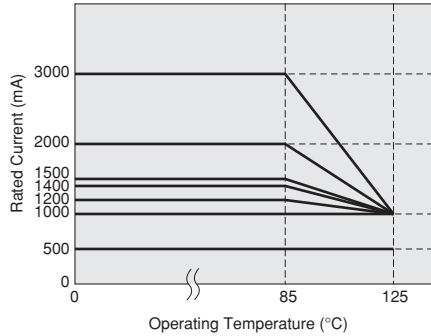
- This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
- This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

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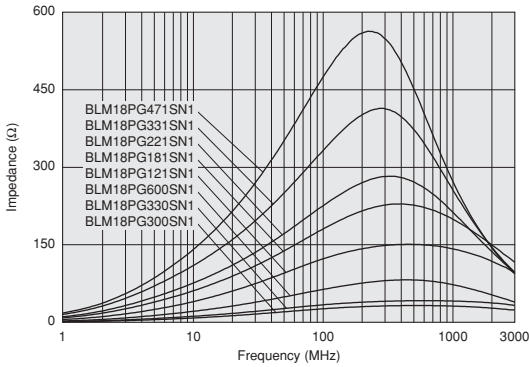
Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM18PG series. Please apply the derating curve shown in chart according to the operating temperature.

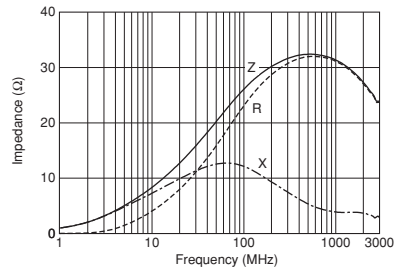
Derating of Rated Current



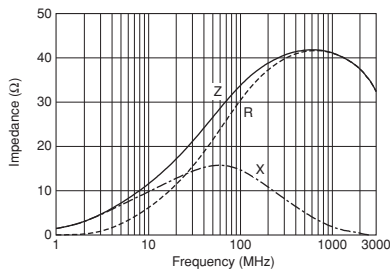
Impedance-Frequency Characteristics (Main Items)



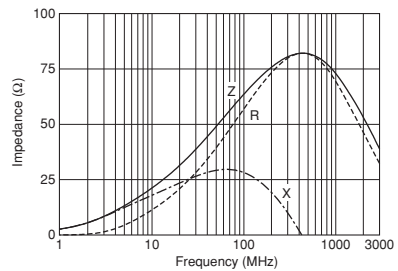
Impedance-Frequency Characteristics BLM18PG300SN1



Impedance-Frequency Characteristics BLM18PG330SN1



Impedance-Frequency Characteristics BLM18PG600SN1



Continued on the following page. ↗

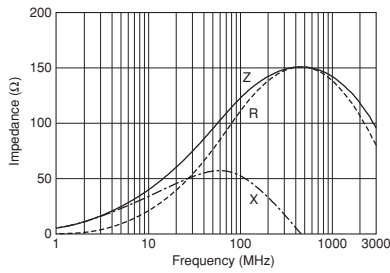
● This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

Note:

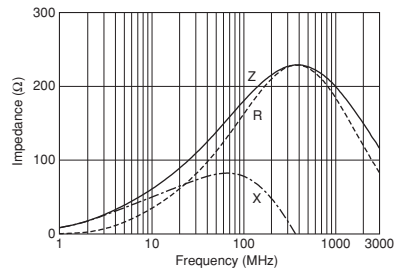
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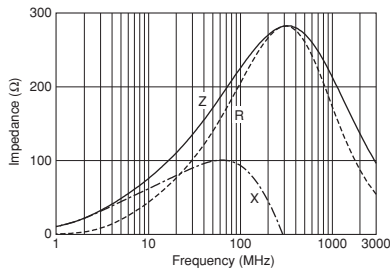
Impedance-Frequency Characteristics
BLM18PG121SN1



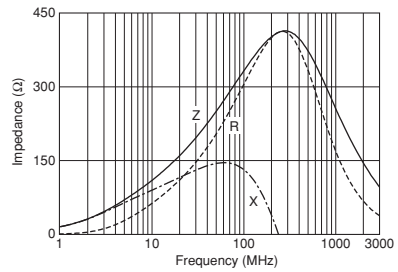
Impedance-Frequency Characteristics
BLM18PG181SN1



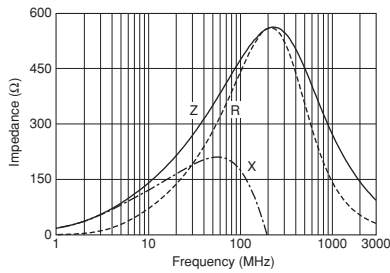
Impedance-Frequency Characteristics
BLM18PG221SN1



Impedance-Frequency Characteristics
BLM18PG331SN1



Impedance-Frequency Characteristics
BLM18PG471SN1




Continued on the following page.

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■ Caution/Notice

Caution (Rating)

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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